

BZX84C 3V3 - BZX84C 33 Series Zeners

Tolerance: C = 5%

Absolute Maximum Ratings*

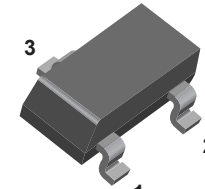
TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
T _{STG}	Storage Temperature Range	-55 to +150	°C
T _J	Maximum Junction Operating Temperature	+ 150	°C
P _D	Total Device Dissipation Derate above 25°C	350 1.8	mW mW/°C
I _{FRM}	Repetitive Peak Forward Current (I _{FRM})	250	mA
I _{ZRM}	Repetitive Peak Working Current (I _{ZRM})	250	mA

*These ratings are limiting values above which the serviceability of the diode may be impaired.

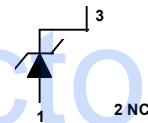
NOTES:

- 1) These ratings are based on a maximum junction temperature of 150 degrees C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.



SOT-23

CONNECTION DIAGRAM



Electrical Characteristics

TA = 25°C unless otherwise noted

Device	Mark	I _{ZT} = 5.0 mA			I _{ZT} = 1.0 mA			I _{ZT} = 20 mA		
		V _Z (V)		Z _Z (Ω)	V _Z (V)		Z _Z (Ω)	V _Z (V)		Z _Z (Ω)
		MIN	MAX		MIN	MAX		MIN	MAX	
BZX84C 3V3	Z14	3.1	3.5	95	2.3	2.9	600	3.6	4.2	40
BZX84C 3V6	Z15	3.4	3.8	90	2.7	3.3	600	3.9	4.5	40
BZX84C 3V9	Z16	3.7	4.1	90	2.9	3.5	600	4.1	4.7	30
BZX84C 4V3	Z17	4.0	4.6	90	3.3	4.0	600	4.4	5.1	30
BZX84C 4V7	Z1	4.4	5.0	80	3.7	4.7	500	4.5	5.4	15
BZX84C 5V1	Z2	4.8	5.4	60	4.2	5.3	480	5.0	5.9	15
BZX84C 5V6	Z3	5.2	6.0	40	4.8	6.0	400	5.2	6.3	10
BZX84C 6V2	Z4	5.8	6.6	10	5.6	6.6	150	5.8	6.8	6
BZX84C 6V8	Z5	6.4	7.2	15	6.3	7.2	80	6.4	7.4	6
BZX84C 7V5	Z6	7.0	7.9	15	6.9	7.9	80	7.0	8.0	6
BZX84C 8V2	Z7	7.7	8.7	15	7.6	8.7	80	7.7	8.8	6
BZX84C 9V1	Z8	8.5	9.6	15	8.4	9.6	100	8.5	9.7	8
BZX84C 10	Z9	9.4	10.6	20	9.3	10.6	150	9.4	10.7	10
BZX84C 11	Y1	10.4	11.6	20	10.2	11.6	150	10.4	11.8	10
BZX84C 12	Y2	11.4	12.7	25	11.2	12.7	150	11.4	12.9	10
BZX84C 13	Y3	12.4	14.1	30	12.3	14.0	170	12.5	14.2	15
BZX84C 15	Y4	13.8	15.6	30	13.7	15.5	200	13.9	15.7	20
BZX84C 16	Y5	15.3	17.1	40	15.2	17	200	15.4	17.2	20
BZX84C 18	Y6	16.8	19.1	45	16.7	19	225	16.9	19.2	20
BZX84C 20	Y7	18.8	21.2	55	18.7	21.1	225	18.9	21.4	20
BZX84C 22	Y8	20.8	23.3	55	20.7	23.2	250	20.9	23.4	25
BZX84C 24	Y9	22.8	25.6	70	22.7	25.5	250	22.9	25.7	25

NOTE: National preferred devices in **BOLD**

BZX84C Series Zeners

(continued)

Electrical Characteristics (continued) TA = 25°C unless otherwise noted

Device	Mark	I _{ZT} = 2.0 mA			I _{ZT} = 100 μA*			I _{ZT} = 10 mA		
		V _Z (V)		Z _Z (Ω)	V _Z (V)		Z _Z (Ω)	V _Z (V)		Z _Z (Ω)
		MIN	MAX		MIN	MAX		MIN	MAX	
BZX84C 27	Y10	25.1	28.9	80	25	28.9	300	25.2	29.3	45
BZX84C 30	Y11	28	32	80	27.8	32	300	28.1	32.4	50
BZX84C 33	Y12	31	35	80	30.8	35	325	31.1	35.4	55

V_F Forward Voltage = 0.9 V Maximum @ I_F = 10 mA for all BZX 84 series

*Capacitance @ VR= 0.0 volts; Frequency = 1.0 megahertz.

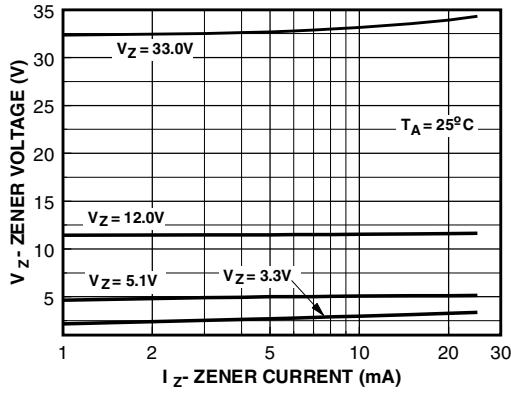
Device	V _R (V)	I _R (μA)	CAP* (pF)	D _{VZ} / D _t @ 5.0 mA (mV/k)	
				MIN	MAX
BZX84C 3V3	1.0	5.0	450	- 3.5	0.0
BZX84C 3V6	1.0	5.0	450	- 3.5	0.0
BZX84C 3V9	1.0	5.0	450	- 3.5	0.0
BZX84C 4V3	1.0	5.0	450	- 3.5	0.0
BZX84C 4V7	2.0	3	260	- 3.5	+ 0.2
BZX84C 5V1	2.0	2	225	- 2.7	+ 1.2
BZX84C 5V6	2.0	1	200	- 2.0	+ 2.5
BZX84C 6V2	4.0	3	185	+ 0.4	+ 3.7
BZX84C 6V8	4.0	2	155	+ 1.2	+ 4.5
BZX84C 7V5	5.0	1	140	+ 2.5	+ 5.3
BZX84C 8V2	5.0	0.7	135	+ 3.2	+ 6.2
BZX84C 9V1	6.0	0.5	130	+ 3.8	+ 7.0
BZX84C 10	7.0	0.2	130	+ 4.5	+ 8.0
BZX84C 11	8.0	0.1	130	+ 5.4	+ 9.0
BZX84C 12	8.0	0.1	130	+ 6.0	+ 10
BZX84C 13	8.0	0.1	120	+ 7.0	+ 11
BZX84C 15	10.5	0.05	110	+ 9.2	+ 13
BZX84C 16	11.2	0.05	105	+ 10.4	+ 14
BZX84C 18	12.6	0.05	100	+ 12.4	+ 16
BZX84C 20	14	0.05	85	+ 14.4	+ 18
BZX84C 22	15.4	0.05	85	+ 16.4	+ 20
BZX84C 24	16.8	0.05	80	+ 18.4	+ 22

Device	V _R (V)	I _R (μA)	CAP* (pF)	D _{VZ} / D _t @ 2.0 mA (mV/k)	
				MIN	MAX
BZX84C 27	18.9	0.05	70	21.4	25.3
BZX84C 30	21	0.05	70	24.4	29.4
BZX84C 33	23.1	0.05	70	27.4	33.4

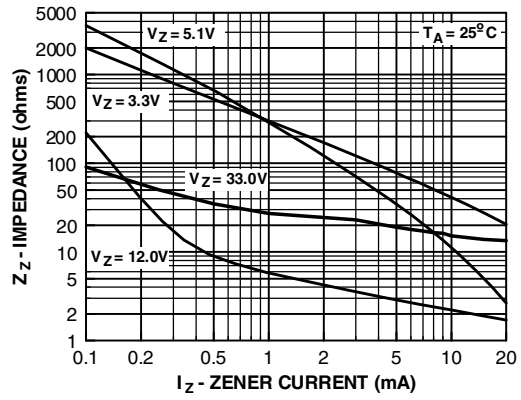
BZX84C 3V3 - BZX84C 33 Series

Typical Characteristics

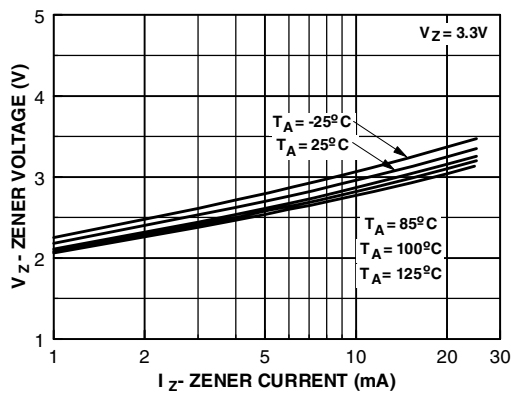
Zener Current vs. Zener Voltage



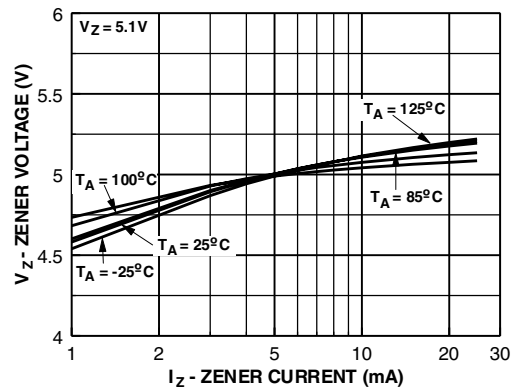
Zener Current vs. Zener Impedance



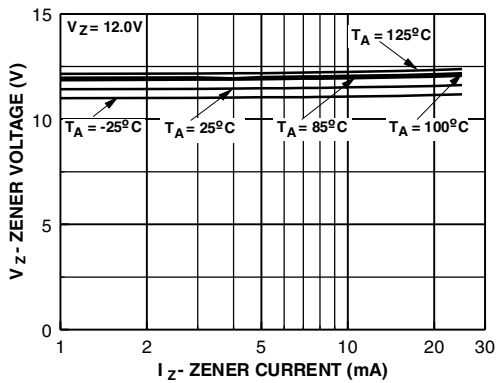
3.3 Zener Voltage vs. Temperature



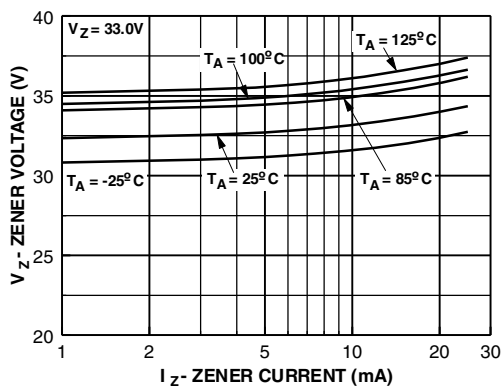
5.1 Zener Voltage vs. Temperature



12 Zener Voltage vs. Zener Temperature



33 Zener Voltage vs. Zener Temperature



SOT-23 Tape and Reel Data



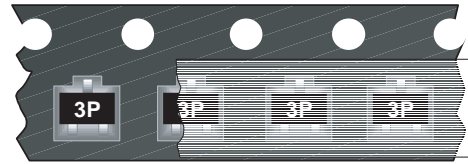
SOT-23 Packaging Configuration: Figure 10



Packaging Description:

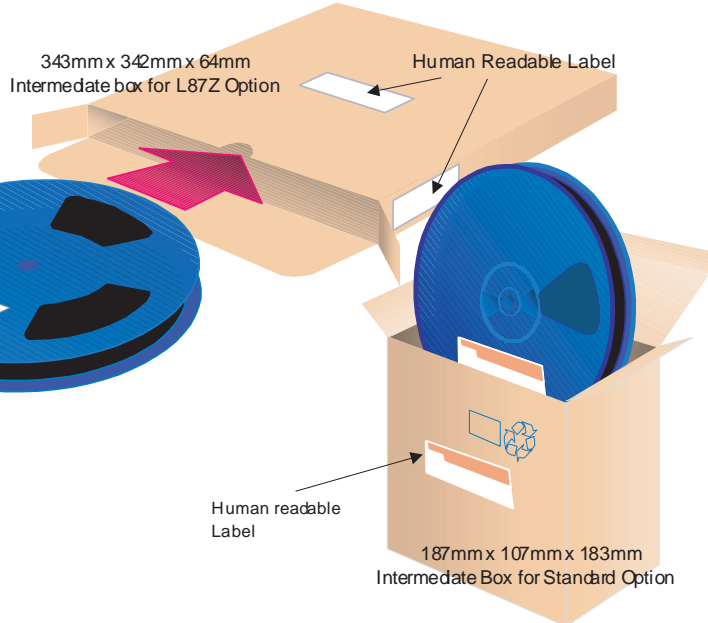
SOT-23 parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 3,000 units per 7" or 177mm diameter reel. The reels are dark blue in color and is made of polystyrene plastic (anti-static coated). Other option comes in 10,000 units per 13" or 330mm diameter reel. This and some other options are described in the Packaging Information table.

These full reels are individually labeled and placed inside a standard intermediate made of recyclable corrugated brown paper with a Fairchild logo printing. One pizza box contains eight reels maximum. And these intermediate boxes are placed inside a labeled shipping box which comes in different sizes depending on the number of parts shipped.



SOT-23 Unit Orientation

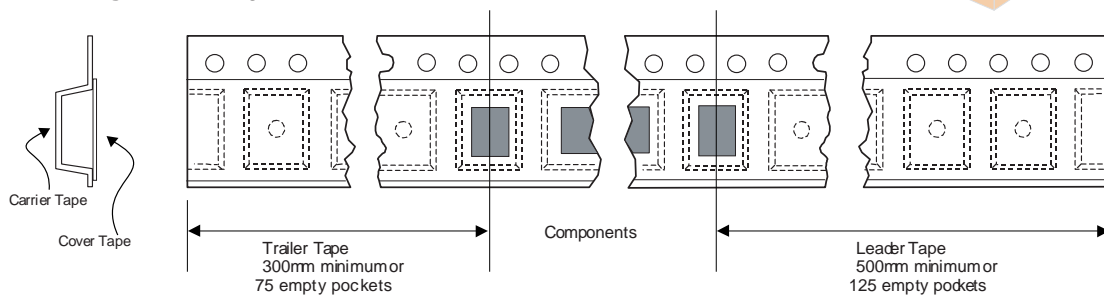
SOT-23 Packaging Information		
Packaging Option	Standard (no flow code)	D87Z
Packaging type	TNR	TNR
Qty per Reel/Tube/Bag	3,000	10,000
Reel Size	7" Dia	13"
Box Dimension (mm)	187x107x183	343x343x64
Max qty per Box	24,000	30,000
Weight per unit (gm)	0.0082	0.0082
Weight per Reel (kg)	0.1175	0.4006
Note/Comments		



Human Readable Label sample



SOT-23 Tape Leader and Trailer Configuration: Figure 20



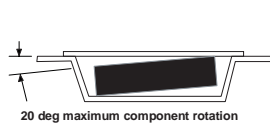
SOT-23 Tape and Reel Data, continued

SOT-23 Embossed Carrier Tape Configuration: Figure 3.0

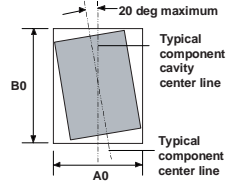


Dimensions are in millimeter														
Pkg type	A0	B0	W	D0	D1	E1	E2	F	P1	P0	K0	T	Wc	Tc
SOT-23 (8mm)	3.15 ±0.10	2.77 ±0.10	8.0 ±0.3	1.55 ±0.05	1.125 ±0.125	1.75 ±0.10	6.25 min	3.50 ±0.05	4.0 ±0.1	4.0 ±0.1	1.30 ±0.10	0.228 ±0.013	5.2 ±0.3	0.06 ±0.02

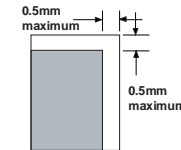
Notes: A0, B0, and K0 dimensions are determined with respect to the EIA/Jedec RS-481 rotational and lateral movement requirements (see sketches A, B, and C).



Sketch A (Side or Front Sectional View)
Component Rotation



Sketch B (Top View)
Component Rotation



Sketch C (Top View)
Component lateral movement

SOT-23 Reel Configuration: Figure 4.0

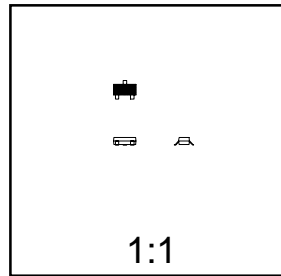


Dimensions are in inches and millimeters									
Tape Size	Reel Option	Dim A	Dim B	Dim C	Dim D	Dim N	Dim W1	Dim W2	Dim W3 (LSL-USL)
8mm	7" Dia	7.00 177.8	0.059 1.5	512 +0.020/-0.008 13 +0.5/-0.2	0.795 20.2	2.165 55	0.331 +0.059/-0.000 8.4 +1.5/0	0.567 14.4	0.311 -0.429 7.9 - 10.9
8mm	13" Dia	13.00 330	0.059 1.5	512 +0.020/-0.008 13 +0.5/-0.2	0.795 20.2	4.00 100	0.331 +0.059/-0.000 8.4 +1.5/0	0.567 14.4	0.311 -0.429 7.9 - 10.9

SOT-23 Package Dimensions



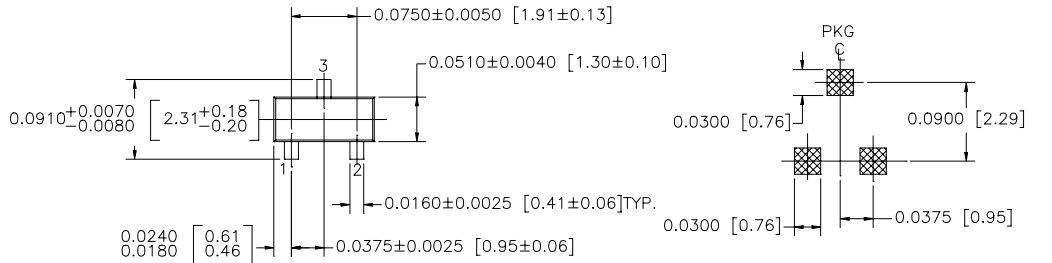
SOT-23 (FS PKG Code 49)



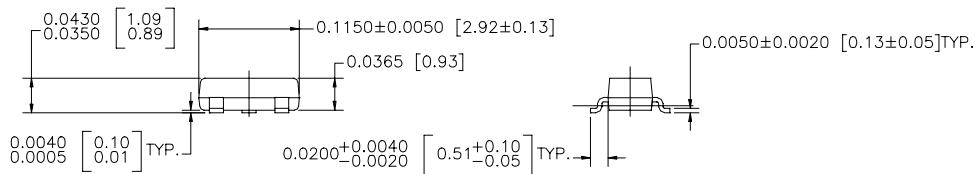
Scale 1:1 on letter size paper

Dimensions shown below are in:
inches [millimeters]

Part Weight per unit (gram): 0.0082



LAND PATTERN RECOMMENDATION



SOT 23, 3 LEADS LOW PROFILE

CONTROLLING DIMENSION IS INCH
VALUES IN [] ARE MILLIMETERS

NOTE : UNLESS OTHERWISE SPECIFIED

- STANDARD LEAD FINISH 150 MICRONS / 3.81 MICROMETERS
MINIMUM TIN / LEAD (SOLDER) ON ALLOY 42
- REFERENCE JEDEC REGISTRATION TO-236, VARIATION AB, ISSUE G, DATED JUL 1993

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DOME™	ISOPANAR™	Quiet Series™	
E ² CMOS™	MICROWIRE™	SILENT SWITCHER®	
EnSigna™	OPTOLOGIC™	SMART START™	
FACT™	OPTOPLANAR™	SuperSOT™-3	
FACT Quiet Series™	PACMAN™	SuperSOT™-6	
FAST®	POP™	SuperSOT™-8	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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